## 'LS320

- Crystal-Controlled Oscillator Operation from 1 MHz to 20 MHz
- 2-Phase Driver Outputs

#### 'LS321

 Similar to 'LS320 But Includes f/2 and f/4 Count-Down Outputs

#### description

The 'LS320 is a crystal-controlled oscillator/clock driver. It features complementary standard and high-current driver outputs. A synchronization flip-flop is included.

The driver outputs, F' and F' have very-low impedance and can be used to drive highly capacitive TTL-level lines. If the driver outputs are not used, then the VCC' terminal can be left open.

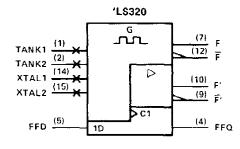
The 'LS321 is identical to the 'LS320 except it additionally features two count-down outputs, F/2 and F/4.

These circuits were designed for crystal control of frequency and capacitive control is not recommended. If a fundamental crystal is used, an inductor of 5 to 160  $\mu H$  is required to be connected between the tank 1 and tank 2 inputs. †

Interaction of the driver outputs with the other outputs limits useful frequencies as shown in the frequency-limits table.

The SN54LS320 and SN54LS321 are characterized for operation over the full military temperature range of —55 °C to 125 °C. The SN74LS320 and SN74LS321 are characterized for operation from 0 °C to 70 °C.

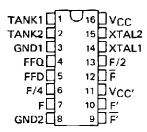
## logic symbols‡



SN54LS320 . . . J OR W PACKAGE SN74LS320 . . . N PACKAGE (TOP VIEW)

TANK1 1	U <sub>16</sub> Dv <sub>CC</sub>
TANK2 2	15 XTAL2
GND1 🛛 3	14 🛚 XTAL1
FFQ∐4	13 🗎 NC
FFD∏5	12 □ F
NC∏6	11 🛮 VCC'
F∏ 7	10 🏳 F′
GND2∏8	9 F'

SN54LS321 . . . J PACKAGE SN74LS321 . . . N PACKAGE (TOP VIEW)

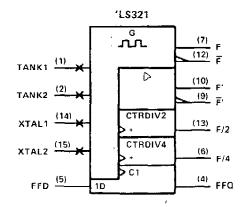


NC - No internal connection

For chip carrier information, contact the factory.

### FREQUENCY LIMITS

OUTPUTS IN USE	Vcc	V <sub>CC</sub> ′	fmax
Driver autputs only	5 V	5 V	20 MHz
Other outputs only	5 V	Open	20 MHz
Driver and any other outputs	5 V	5 V	10 MHz



<sup>†</sup>The value of the inductor is selected from the graph in Figure 2. Use the next higher standard inductor value if the selected value is not available. If a third overtone crystal is used, a funed tank is necessary. The center frequency of the tuned tank is determined by the equation f = ½ π/LC.

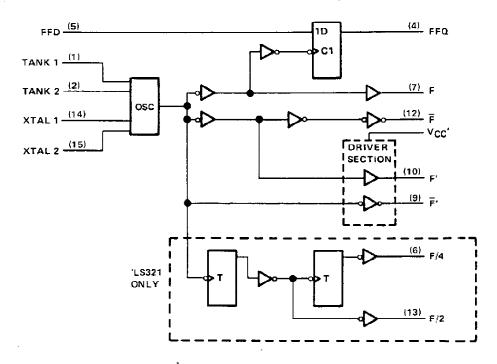
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<sup>&</sup>lt;sup>‡</sup>These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

# SN54LS320, SN54LS321, SN74LS320, SN74LS321 CRYSTAL-CONTROLLED OSCILLATORS

# , logic diagram (positive logic)



# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note	1)																	. 7 V
Supply voltage, VCC'																		7 V
Input voltage to FFD terminal	-								-			_	 -	-			-0.5 V	to 7 V
Operating free-air temperature	range:	SN5	4LS	320,	SN	54 L	.\$32	1									$-55^{\circ}$ C to	125°C
		SN7	4LS	320,	SN	74L	.S32	1									. 0°C t	ه 70°C
Storage temperature range .																,	-65°C to	150°C

NOTE 1: Voltage values are with respect to network ground terminals.

# recommended operating conditions

			SN54LS3 SN54LS3			UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	1
Supply voltage, V <sub>CC</sub>		4.5	5	5.5	4.75	5	5.25	V
Supply valtage, V <sub>CC</sub> '		4.5	5	5.5	4.75	5	5.25	V
	F' or F'			-12			-24	mA
High-level output current, IOH	F, F, F/2, F/4			-0.4			-0.4	] '''``
Low level content or content	F' or F'			12			24	mA
Low-level output current, IOL	F, F, F/2, F/4			4			8	1 '''`
	F/2 ('L\$321)	0.5		10	0.5		10	
Output frequency, fout	F/4 ('LS321)	0.25		5	0.25		5	MHz
	ForF	1	-	20	1	5 5.25 5 5.25 -24 -0.4 24 8 10 5	1	
Operating free-air temperature, TA		-55		125	0		70	°c

Input and output schematics are similar to those shown for SN74LS326.



# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			T	1 -	N54LS3 N54LS3		S S	UNIT				
				MIN	TYP	MAX	MIN TYP‡		MAX			
VIH	High-level input	voltage				2			2			V
VII	Low-level input	voltage			· ·			0.7			0.8	V
VIK	Input clamp vol	tage	V <sub>CC</sub> = MIN,	V <sub>CC</sub> ' = MIN,	! <sub> </sub> = −18 mA			-1.5			-1.5	V
<u> </u>			V <sub>CC</sub> = 4.5 V,	V <sub>CC</sub> ' = 4.5 V,	1 <sub>OH</sub> = -12 mA	2.4	3.3					
VOH	High-level	F', F'	V <sub>CC</sub> = 4.75 V,	V <sub>CC</sub> ' = 4.75 V,	I <sub>OH</sub> = -24 mA				2.7	3.3		<b>'</b>
ļ	output voltage	Others	V <sub>CC</sub> = MIN,	V <sub>1H</sub> = 2 V,	IOH = -400 μA	2.4	3.4		2.7	3.4		
<del></del>		E. E.	14 1411	37 2 84181	10L = 12 mA	ļ	0.25	0.4		0.25	0.4	
<b> </b> ,, .	Low-level	F', F'	V <sub>CC</sub> = MIN,	= MIN, VCC' = MIN	10L = 24 mA					0.35	0.5	V
VOL	output voltage		VCC = MIN,	34 - 34	I <sub>OL</sub> = 4 mA		0.25	0.4		0.25	0.4	] *
1	-	Others		VIL = VIL max	IOL = 8 mA					0.35	0.5	
1,	Input current at maximum input		V <sub>CC</sub> = MAX,	V <sub>1</sub> = 7 V			_	0.1			0.1	mA
1 <sub>1H</sub>	High-level input	current	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 2.7 V				20			20	μA
TIL	Low-level input	current	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.4 V				-0.4			-0.4	mA
los	Shart-circuit		V <sub>CC</sub> = MAX	<del>.</del>		-20		-100	-20		-100	mA
	Supply current			555 645	'L\$320		42	70		42	70	
Icc	from V <sub>CC</sub>		V <sub>CC</sub> = MAX,	FFD at GND	'LS321	1	47	75		47	75	mA
¹CC'	Supply current from V <sub>CC</sub> '		V <sub>CC</sub> = MAX,	V <sub>CC</sub> ' = MAX,	FFD at GND		4	8		4	8	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $V_{CC}' = 5 \text{ V}$ , and  $T_A = 25^{\circ}\text{C}$ ,

# switching characteristics, VCC = 5 V, VCC = 5 V, TA = 25°C

han and Tro		0.150150		'LS320			UNIT					
	PARAMETER	OUTPUTS	TEST CO	MIN	TYP	MAX	MIN	TYP	MAX	UNIT		
		F/2		D = 667 D				10	15			
fmax	Maximum operating	F/4	CL = 100 pF	R <sub>L</sub> ≃667Ω				5	7.5		MHz	
	frequency	All others		$R_L = 2 k\Omega$	20	30		20	30			
t <sub>r</sub>			CL = 50 pF	R <sub>L</sub> = 667 Ω		6	12		6	12		
	Rise time, 1 V to 3 V	F', F'	CL = 100 pF			7	14		7	14		
			C <sub>L</sub> = 200 pF			7	14		7	14	ns	
			C <sub>L</sub> = 50 pF			11	22		11	22	,,,,	
		Others	նլ = 100 pF	R_=2kΩ		25	40		25	40	ļ	
			C <sub>L</sub> = 200 pF			45	70		45	70	<u> </u>	
			C <sub>L</sub> = 50 pF			5	10		5	10		
		F', F'	C <sub>L</sub> = 100 pF	$R_L = 667 \Omega$ $R_L = 2 k\Omega$	R <sub>L</sub> = 667 Ω	R <sub>L</sub> = 667 Ω	5	10		5	10	
	E-Daine O.V. 4.V	+	C <sub>L</sub> = 200 pF			6	12		6	12	1	
tr	Fall time, 3 V to 1 V		C <sub>L</sub> = 50 pF		6	12		6	12	ns		
		Others	CL = 100 pF			10	20		10	20	]	
			C <sub>L</sub> = 200 pF			17	30		17	30	Ī	

Load circuits and voltage waveforms are shown in Section 1.



SNot more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second. Outputs F' and F' do not have short-circuit protection and these limits do not apply.

## **TYPICAL APPLICATION DATA**

The SN54/74LS320 and 'LS321 are crystal-controlled oscillators. Figure 1 shows the device with all required external components.

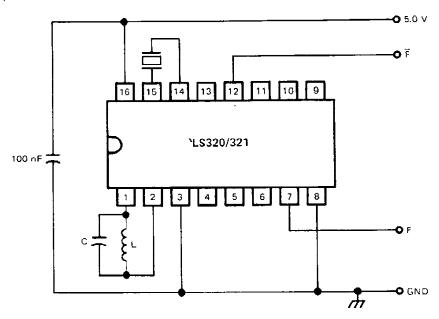


FIGURE 1. CRYSTAL-CONTROLLED OSCILLATOR 'LS320/321

- 1. Determination of C and L are as follows:
  - a. Inductance L

Select Inductance L according to Figure 2.

b. Capacitor C

$$C = Cs-Cp-CL$$

Where:

Cp = parasitic board capacitance

C<sub>L</sub> = parasitic capacitance of the inductor

L = inductance

Cs = required capacitance calculated as follows:

$$C_S = \frac{1}{(2 \cdot \pi \cdot f_Q)^2 \cdot L}$$

$$for f_q > 12 MHz, C = 0 pf$$

2. Electrical characteristic for the crystal:

The quartz crystal used as a frequency reference should be designed for series mode operation with a resistance in the 20  $\Omega$  to 75  $\Omega$  range and be capable of a minimum 2 mw power dissipation.

It is recommended to use a tuned tank also for fundamental crystals.

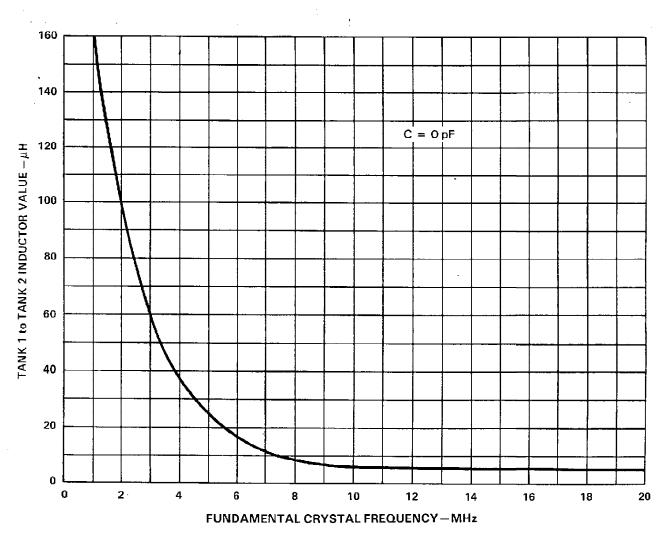


FIGURE 2

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